

PSR-4000 GP01EU Colors (UL Name: PSR-4000HA/CA-40HA)

LIQUID PHOTOIMAGEABLE SOLDER MASK

- Screen Print Application
- Black, Blue, Clear, Red and White SatinFinish
- **RoHS** Compliant
- Excellent Coating Properties
- **Over Set Weighter Compatible with Lead-Free Processing**
- **Solution** Excellent Small Hole Clearing
- **Wide Processing Window**
- **Fine Dam Resolution**
- **Withstands ENIG & Immersion Tin**
- **Over Service** Low Odor

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Revised March 31, 2016



PROCESSING PARAMETERS FOR PSR-4000 GP01EU COLORS

PSR-4000 GP01EU Colors is a two-component, alkaline developable LPI solder mask products for screen print application. The product is designed to be user friendly with wide processing latitudes, low odor, fast developing and good resistance to alternate metal finishes such as ENIG and immersion Tin. All Taiyo America products comply with the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the Restriction of the use of certain Hazardous Substances (RoHS) in electrical and electronic equipment.

PSR-4000 GP01EU COLORS COMPONENTS: PSR-4000 GP01EU Colors / CA-40 GP01 Mixing Ratio 70 parts 30 parts Black, Blue, Clear White Color Red and White Mixed Properties prior to PMA Dilution Solids 80% Viscosity 220-270ps Specific Gravity 1.5 MIXING **PSR-4000 GP01EU Colors** is supplied in pre-measured containers with a mix ratio by weight of 70 parts, 2.8 kgs, PSR-4000 GP01EU Colors and 30 parts, 1.2 kgs, CA-40 GP01. PSR-4000 GP01EU Colors can be mixed a mechanical mixer at low speeds to minimize shear thinning for 10 – 15 minutes. **PRE-CLEANING** Prior to solder mask application, the printed circuit board surface needs to be cleaned. Various cleaning methods include Pumice, Aluminum Oxide, Mechanical Brush, and Chemical Clean. All of these methods will provide a clean surface for the application of PSR-4000 GP01EU Colors. Hold time after cleaning the printed circuit board should be held to a minimum to reduce the oxidation of the copper surfaces.

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Revised March 31, 2016

2675 Antler Drive • Carson City, NV 89701 • Phone [775] 885-9959 • Fax [775] 885-9972 • www.taiyo-america.com

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	Printing Mode: Flood / Print / Print
	 Flood Pressure: 20 – 30 psi Printing Speed: 2.0 – 9.9 inches/sec Printing Pressure: 60 – 100 psi
TACK DRY CYCLE	 The Tack Dry step is required to remove solvent from the solder mask film and produce a firm dry surface. The optimum dwell time and oven temperature will depend on oven type, oven loading, air circulation, exhaust rate, and ramp times. Excessive tack dry times and temperature will result in difficulty developing solder mask from through holes and a reduction in photo speed. Insufficient tack dry will result in artwork marking and/or sticking. Typical tack dry condition for PSR-4000 GP01EU Colors is as follows: Oven Temperature: 160 - 175°F (71 - 79°C) For Single-Sided (Batch Oven)

EXPOSURE

PSR-4000 GP01EU Colors requires UV exposure to define solder mask dams and features. The spectral sensitivity of **PSR-4000 GP01EU Colors** is in the area of 365 nm. Exposure times will vary by bulb type and age of the bulb. Below are guidelines for exposing **PSR-4000 GP01EU Colors**.

- Exposure Unit: 7 kW or higher
- See table for Energy and Stouffer Step per Color

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PROCESSING PARAMETERS FOR PSR-4000 GP01EU COLORS

EXPOSURE (CONTINUED	b)		
PSR-4000 GP01 EU Colors	Exposure Energy	Stouffer Step Range	Resolution Capabilities*
Black	Minimum 500 mJ/cm ²	9 – 11	4 mil dams
Blue	Minimum 400 mJ/cm ²	10 – 12	3 mil dams
Clear	Minimum 200 mJ/cm ²	9 – 11	3 mil dams
Red	Minimum 400 mJ/cm ²	10 – 12	3 mil dams
White	Minimum 500 mJ/cm ²	10 - 12	4 mil dams

*At coating thicknesses of 30 microns or less.

DEVELOPMENT

PSR-4000 GP01EU Colors is developed in an aqueous sodium or potassium carbonate solution. Developing can be done in either a horizontal or vertical machine.

- Solution: 1% by wt. Sodium Carbonate or 1.2% Potassium Carbonate
- pH: 10.6 or greater
- Temperature: 85 95°F (29 35°C)
- Spray Pressure: 25 45 psi (1.7 3.1 bars)
- Dwell Time in developing chamber: 45 120 seconds
- Water rinse is needed to remove developer solution followed by a drying step

PRE CURE (OPTIONAL) This step may be required if the vias remain tented on both sides after developing due to the board design. The added drying cycle will prevent out-gassing of the vias. This phenomenon can cause the solder mask over the vias to peel or pop and may also exhibit a degree of oozing due to the entrapped solvent. The required drying cycle is 80

- 110°C for 40 to 60 minutes. An extended time may be required on the higher aspect ratio.

FINAL CURE PSR-4000 GP01EU Colors requires a thermal cure to insure optimal final property performance. Thermal curing can be done in a batch oven or conveyorized oven.

- Temperature: 275 300°F (135 149°C)
- Time at Temperature: 45 60 minutes

For Process Optimization please contact your local Taiyo America Representative

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FINAL PROPERTIES FOR PSR-4000 GP01EU COLORS

ltem	Test Conditions	Results	
CTI (Comparative Tracking Index – Green Satin			
Adhesion	Taiyo internal method Cross hatch peeling	100/100	
Pencil Hardness	Taiyo internal method No scratch on copper	7H	
Halogen Content	Halogen Content JPCA standards of less than 900 ppm Halogens= "Halogen Free"		
Solder Heat Resistance	Rosin flux 260°C/10sec, 3cycles	Pass	
Solvent Resistance	Solvent Resistance PGM-Ac, 20°C, 20 min. Immersion and tape test		
Acid Resistance 10vol%H ₂ SO ₄ , 20°C, 20 min. Immersion and tape test		Pass	
Alkaline Resistance	10wt%NaOH, 20°C, 20 min. Immersion and tape test	Pass	
Insulation Resistance	Initial: 6.6x10 ¹³ Ω Conditioned: 2.4x10 ¹² Ω		
Dielectric Constant	Taiyo internal method Values at 1MHz Humidification: 25~65°C cycle 90%%RH for 7 days Measurement: After the above treatment, measured at room temperature	Initial: 4.1 Final 4.7	
Dissipation Factor	Taiyo internal method Values at 1MHz Humidification: 25~65°C cycle 90%%RH for 7 days Measurement: After the above treatment, measured at room temperature	Initial: 0.022 Final: 0.023	
Тд	Internal Test (TMA)	130° C	
CTE	Internal Test (TMA) alpha 1 / alpha 2	75 / 140	
Electrolytic gold plating	Internal lab test:		
Electroless gold plating	Pass		

Taiyo America, Inc. (TAIYO) warrants its products to be free from defects in materials and workmanship for the specified warranty period (PSR-4000 GP01EU Colors / CA-40 GP01 Warranty period is 12 Months) provided the customer has, at all times, stored the ink at a temperature of 68°F or less. TAIYO accepts no responsibility or liability for damages, whether direct, indirect, or consequential, resulting from failure in the performance of its products. If a TAIYO product is found to be defective in material or workmanship, its liability is limited to the purchase price of the product found to be defective. TAIYO MAKES NO OTHER WARRANTY, EXPRESS OR IMPLIED, AND MAKES NO WARRANTY OF MERCHANTABILITY OR OF FITNESS FOR ANY PARTICULAR PURPOSE. TAIYO'S obligation under this warranty shall not include any transportation charges or costs of installation or any liability for direct, indirect, or consequential damages or delay. If requested by TAIYO, products for which a warranty claim is made are to be returned transportation prepaid to TAIYO'S factory. Any shall void this limited warranty.

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